# 2SB0944 (2SB944)

### Silicon PNP epitaxial planar type

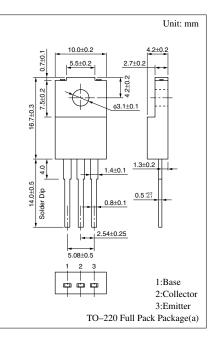
For power switching Complementary to 2SD1269

#### Features

- Low collector to emitter saturation voltage  $V_{CE(sat)}$
- Satisfactory linearity of foward current transfer ratio h<sub>FE</sub>
- Large collector current I<sub>C</sub>
- Full-pack package which can be installed to the heat sink with one screw

Parameter		Symbol	Ratings	Unit			
Collector to base voltage		V <sub>CBO</sub>	-130	V			
Collector to emitter voltage		V <sub>CEO</sub>	-80	V			
Emitter to base voltage		$V_{EBO}$	-7	V			
Peak collector current		I <sub>CP</sub>	-8	А			
Collector current		I <sub>C</sub>	-4	А			
Collector power	T <sub>C</sub> =25°C	D	35	w			
dissipation	Ta=25°C	P <sub>C</sub>	2				
Junction temperature		Tj	150	°C			
Storage temperature		T <sub>stg</sub>	-55 to +150	°C			

#### Absolute Maximum Ratings $(T_c=25^{\circ}C)$



#### Electrical Characteristics $(T_c=25^{\circ}C)$

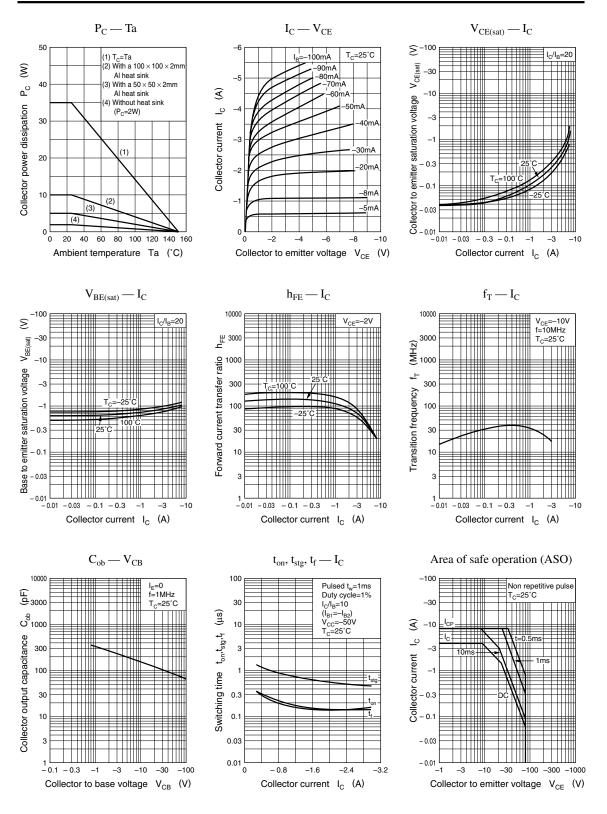
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = -100V, I_E = 0$			-10	μΑ
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = -5V, I_C = 0$			-50	μΑ
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$	-80			V
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = -2V, I_C = -0.1A$	45			
	h <sub>FE2</sub> *	$V_{CE} = -2V, I_C = -1A$	90		260	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -3A, I_{\rm B} = -0.15A$			- 0.5	v
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = -3A, I_{\rm B} = -0.15A$			-1.5	v
Transition frequency	f <sub>T</sub>	$V_{CE} = -10V, I_C = -0.5A, f = 10MHz$		30		MHz
Turn-on time	t <sub>on</sub>			0.15		μs
Storage time	t <sub>stg</sub>	$I_{C} = -1A, I_{B1} = -0.1A, I_{B2} = 0.1A$		0.8		μs
Fall time	t <sub>f</sub>			0.15		μs

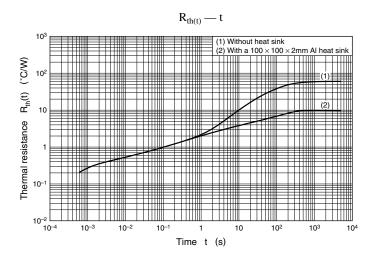
\*hFE2 Rank classification

Rank	Q	Р
h <sub>FE2</sub>	90 to 180	130 to 260

Note: Ordering can be made by the common rank (PQ rank  $h_{FE2} = 90$  to 260) in the rank classification.

Note.) The Part number in the Parenthesis shows conventional part number.





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